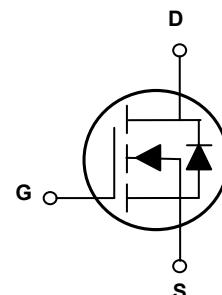
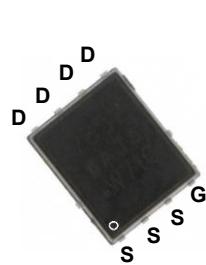


Main Product Characteristics

BV _{DSS}	60V
R _{DS(ON)}	3.5mΩ @10V (Typ)
	5.5mΩ @4.5V (Typ)
I _D	95A



Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



Description

The GSFP0694 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supplies and a wide variety of other applications.

Absolute Maximum Ratings ($T_J=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	V _{DS}	60	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous ($T_C=25^\circ\text{C}$)	I _D	95	A
Drain Current-Continuous ($T_C=70^\circ\text{C}$)		76	
Drain Current-Pulsed ($T_C=25^\circ\text{C}$) ¹	I _{DM}	350	A
Diode Continuous Forward Current ($T_C=25^\circ\text{C}$)	I _S	95	A
Power Dissipation ($T_C=25^\circ\text{C}$)	P _D	83	W
Avalanche Energy, Single Pulsed ²	E _{AS}	194	mJ
Thermal Resistance, Junction-to-Case	R _{θJC}	1.5	°C/W
Operating Junction Temperature Range	T _J	-55 To +150	°C
Storage Temperature Range	T _{STG}	-55 To +150	°C

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_D=250\mu\text{A}$	65	-	-	V
Zero Gate Voltage Drain Current, $T_C=25^\circ\text{C}$	I_{DSS}	$V_{\text{DS}}=60\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	μA
Zero Gate Voltage Drain Current, $T_C=125^\circ\text{C}$		$V_{\text{DS}}=48\text{V}, V_{\text{GS}}=0\text{V}$	-	-	100	μA
Gate-Source Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
On Characteristics						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}}=V_{\text{DS}}, I_D=250\mu\text{A}$	1.0	1.5	2.5	V
Drain-Source On-State Resistance ³	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}, I_D=15\text{A}$	-	3.5	4.5	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_D=8\text{A}$	-	5.5	7.5	$\text{m}\Omega$
Dynamic and Switching Characteristics						
Total Gate Charge	Q_g	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=10\text{V}, I_D=20\text{A}$	-	56.1	-	nC
Gate-Source Charge	Q_{gs}		-	8.9	-	
Gate-Drain Charge	Q_{gd}		-	14.4	-	
Turn-On Delay Time	$T_{\text{d}(\text{on})}$	$V_{\text{DD}}=30\text{V}, V_{\text{GS}}=10\text{V}, R_G=3.3\Omega, I_D=5\text{A}$	-	10.6	-	nS
Rise Time	T_r		-	16.5	-	
Turn-Off Delay Time	$T_{\text{d}(\text{off})}$		-	48	-	
Fall Time	T_f		-	78	-	
Input Capacitance	C_{iss}	$V_{\text{DS}}=35\text{V}, V_{\text{GS}}=0\text{V}, F=1\text{MHz}$	-	2820	-	pF
Output Capacitance	C_{oss}		-	1030	-	
Reverse Transfer Capacitance	C_{rss}		-	60	-	
Gate Resistance	R_g	$F=1\text{MHz}$	-	2.8	-	Ω
Drain-Source Diode Characteristics and Maximum Ratings						
Diode Forward Voltage ³	V_{SD}	$V_{\text{GS}}=0\text{V}, I_{\text{SD}}=15\text{A}$	-	0.78	1.2	V
Reverse Recovery Time	t_{rr}	$I_{\text{SD}}=20\text{A}, V_{\text{GS}}=0\text{V}$ $dI/dt=500\text{A}/\mu\text{s}$	-	45	-	nS
Reverse Recovery Charge	Q_{rr}		-	163	-	nC

Note:

- Repetitive rating: Pulsed width limited by maximum junction temperature.
- $V_{\text{GS}}=10\text{V}, L=0.3\text{mH}, I_{\text{AS}}=36\text{A}, R_G=25\Omega$, starting $T_J=25^\circ\text{C}$.
- Pulse test: pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.

Typical Electrical and Thermal Characteristic Curves

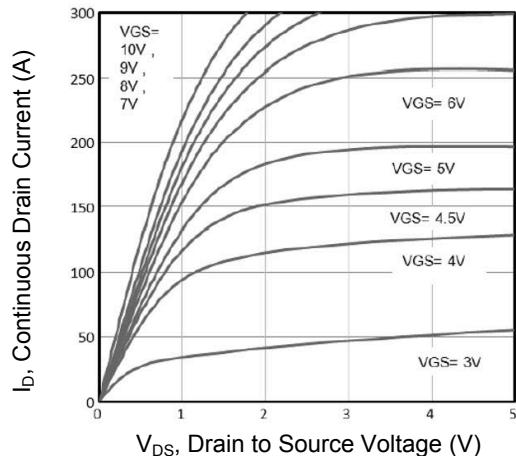


Figure 1. Typical Output Characteristics

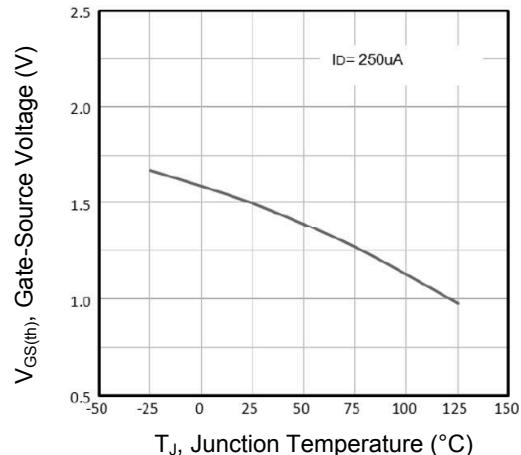


Figure 2. $V_{GS(th)}$ vs. T_J

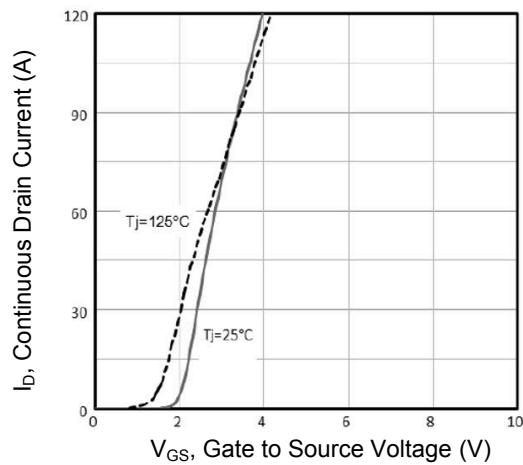


Figure 3. Typical Transfer Characteristics

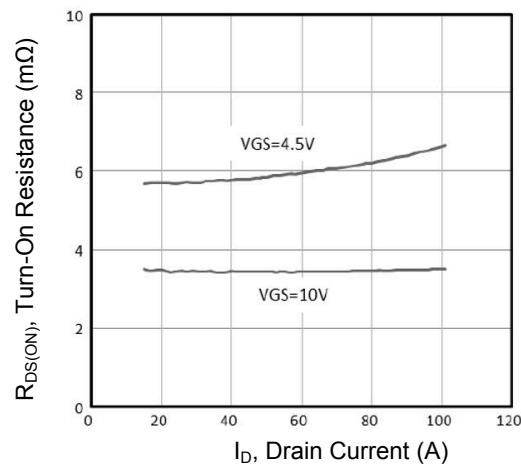


Figure 4. Turn-On Resistance vs. I_D

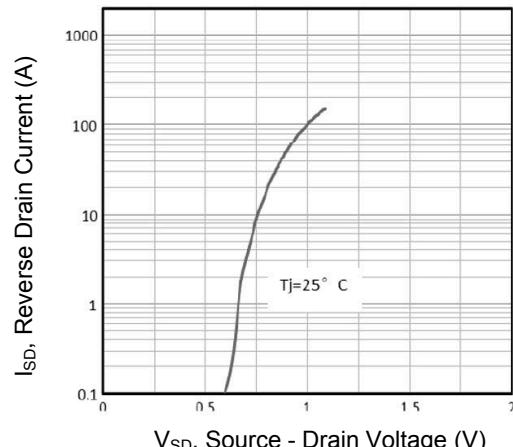


Figure 5. Typical Source - Drain Diode Forward Voltage

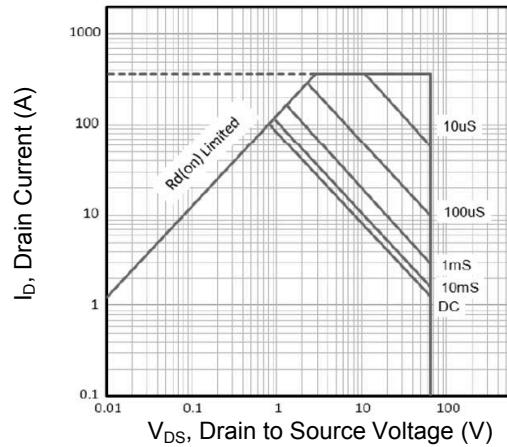


Figure 6. Maximum Safe Operating Area

Typical Electrical and Thermal Characteristic Curves

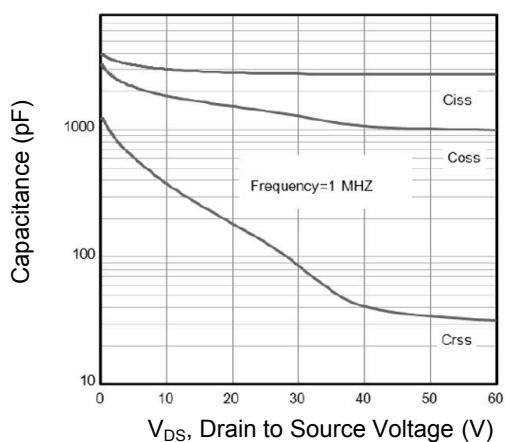


Figure 7. Capacitance Characteristics

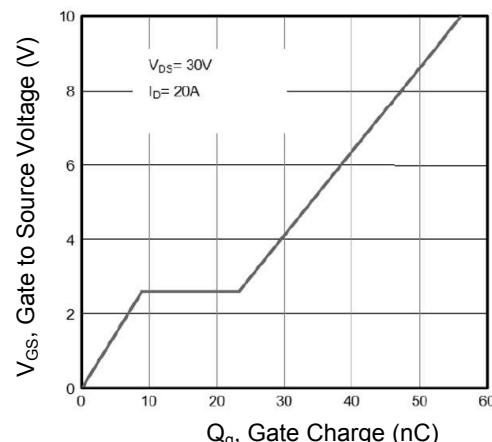


Figure 8. Gate Charge Characteristics

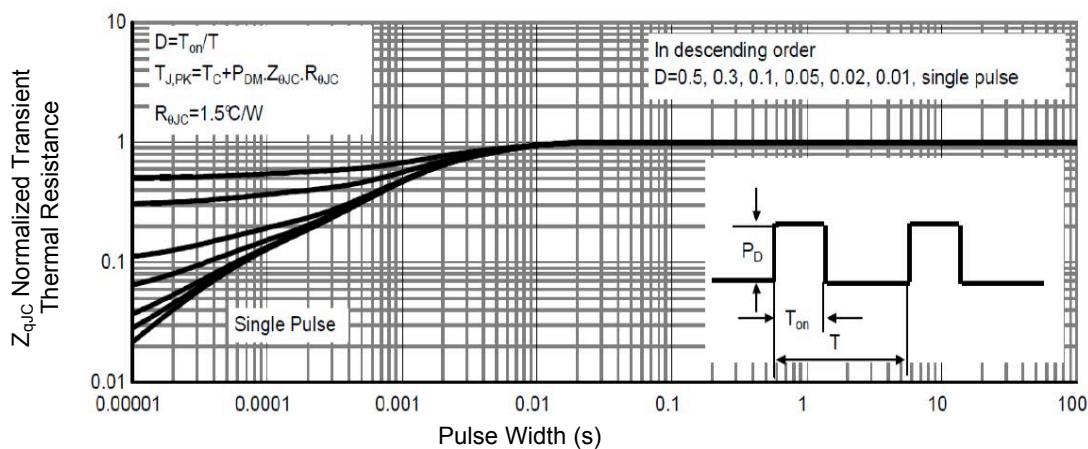


Figure 9. Normalized Maximum Transient Thermal Impedance

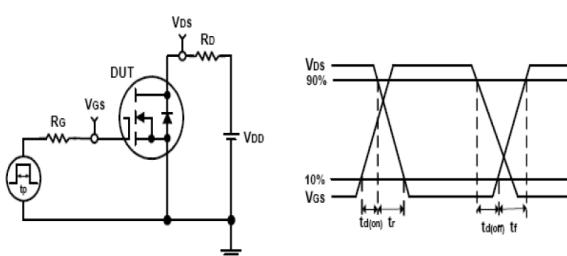


Figure 10. Switching Time Test Circuit and Waveforms

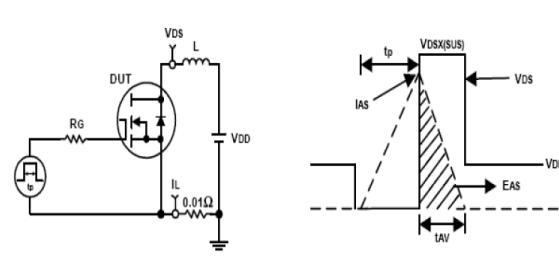
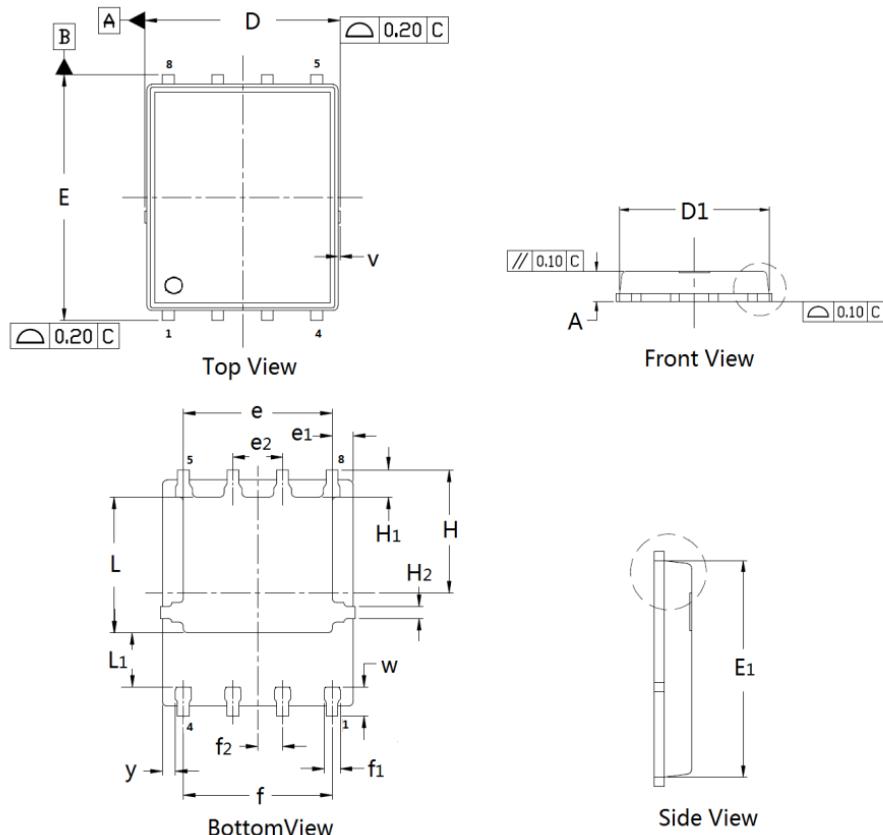


Figure 11. Unclamped Inductive Test Circuit and Waveforms

Package Outline Dimensions (PPAK5x6)



Symbol	Dimensions in Millimeters			Symbol	Dimensions in Millimeters		
	Min	Typ	Max		Min	Typ	Max
A	0.90	1.02	1.10	D	4.90	4.98	5.10
D1	4.80	4.89	5.00	E	6.00	6.11	6.20
E1	5.65	5.74	5.85	e	3.72	3.80	3.92
e1	-	0.54	-	e2	-	1.27	-
f	-	3.82	-	f1	0.31	0.37	0.51
f2	-	0.64	-	H	-	3.15	-
H1	0.59	0.63	0.79	H2	0.26	0.28	0.32
L	3.38	3.45	3.58	L1	-	1.39	-
v	-	0.13	-	w	0.64	0.68	0.84
y	-	0.34	-				

Order Information

Device	Package	Marking	Carrier	Quantity
GSFP0694	PPAK5x6	004N06	Tape / Reel	4,000 pcs / Reel